Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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Notice

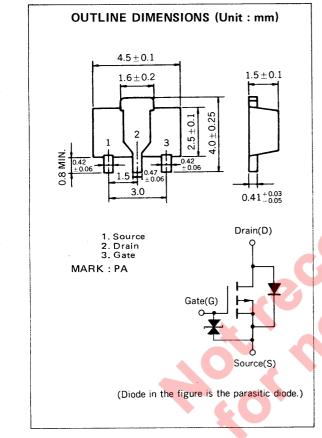
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DATA SHEET

Renesas

MOS FIELD EFFECT TRANSISTOR 2SJ179

P-CHANNEL MOS FET FOR HIGH-SPEED SWITCHING



The 2SJ179, P-channel vertical type MOS FET, is a switching device which can be driven directly by the output of ICs having a 5 V power source.

As the MOS FET has low on-state resistance and excellent switching characteristics, it is suitable for driving actuators such as motors, relays, and solenoids.

FEATURES

- Directly driven by ICs having a 5 V power supply.
- Has low on-state resistance

 $R_{DS(on)} = 1.5 \Omega MAX. @V_{GS} = -4.0 V, I_{D} = -0.5 A$

- $R_{DS(on)} = 1.0 \Omega MAX. @V_{GS} = -10 V, I_{D} = -0.5 A$
- Bidirectional Zener Diode for protection is incorporated between Gate and Source.
- Inductive loads can be driven without protective circuit thanks to the improved breakdown voltage between Drain and Source.

QUALITY GRADE

Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

CHARACTERISTIC	SYMBOL	CONDITIONS	RATINGS	UNIT
Drain to Source Voltage	V _{DSS}	V _{GS} = 0	-30	V
Gate to Source Voltage	V _{GSS}	V _{DS} = 0	Ŧ20	V
Drain Current	D(DC)		¥1.5	А
Drain Current	D(pulse)	$PW \leq 10 \text{ ms}$, Duty Cycle $\leq 50 \%$	Ŧ3.0	А
Total Power Dissipation	PT	when using ceramic board of 0.7 mm \times 16 cm ²	2.0	w
Channel Temperature	T _{ch}		150	°C
Storage Temperature	T _{stg}		-55 to +150	°C

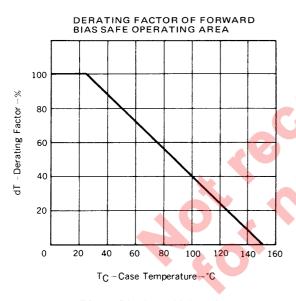
ABSOLUTE MAXIMUM RATINGS (T_a = 25 $^{\circ}$ C)

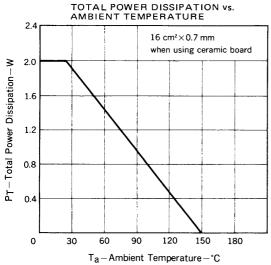
Document No. TC-2317A (0.D.No. TC-7775B) Date Published November 1994 M Printed in Japan

ELECTRICAL CHARACTERISTICS (T_a = 25 $^{\circ}$ C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS	
Drain Cut-off Current	IDSS			-10	μA	$V_{DS} = -30 V, V_{GS} = 0$	
Gate Leakage Current	IGSS			Ŧ10	μA	V _{GS} = ∓20 V, V _{DS} = 0	
Gate Cut-off Voltage	V _{GS(off)}	-1.0	-2.2	-3.0	V	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$	
Forward Transfer Admittance	y _{fs}	0.4			S	V _{DS} = -10 V, I _D = -0.5 A	
Drain to Source On-State Resistance	R _{DS(on)1}		0.8	1.5	Ω	V _{GS} = -4.0 V, I _D = -0.5 A	
Drain to Source On-State Resistance	R _{DS(on)2}		0.4	1.0	Ω	$V_{GS} = -10 V, I_D = -0.5 A$	
Input Capacitance	Ciss		210		pF		
Output Capacitance	Coss		130		pF	V _{DS} = –10 V, V _{GS} = 0, f = 1 MHz	
Feedback Capacitance	C _{rss}		3		pF		
Turn-On Delay Time	^t d(on)		35		ns		
Rise Time	t _r		70		ns	- V _{GS(on)} = –10 V, R _G = 10 Ω, V _{DD} = = –25 V,	
Turn-Off Delay Time	^t d(off)		380		ns	$I_{\rm D} = -0.5 \text{ A}, \text{ R}_{\rm L} = 50 \Omega$	
Fall Time	t _f		200		ns		

TYPICAL CHARACTERISTICS (T_a = 25 $^{\circ}$ C)





FORWARD BIAS SAFE OPERATING AREA

VDS-Drain to Source Voltage-V DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

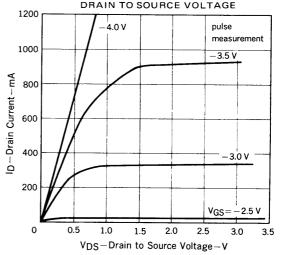
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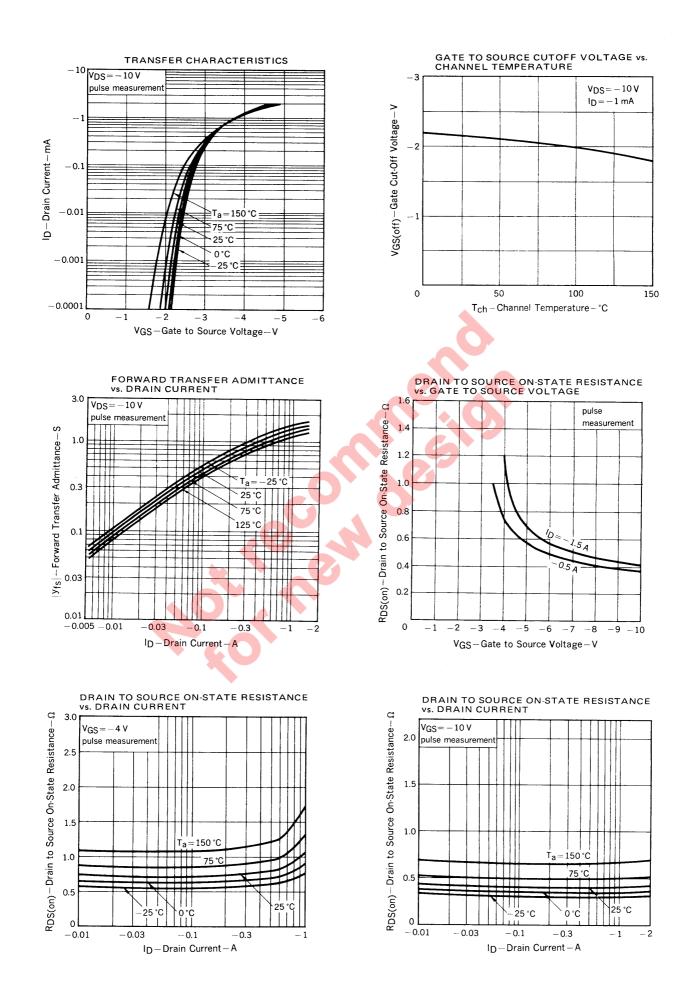
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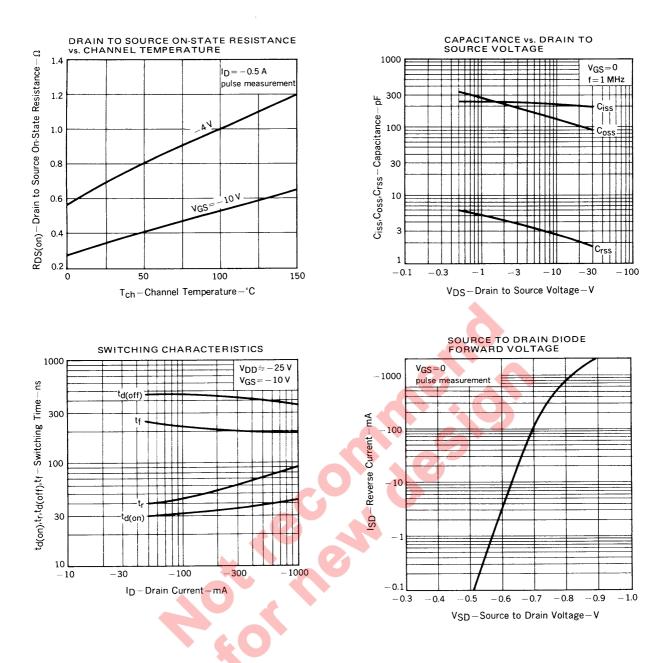


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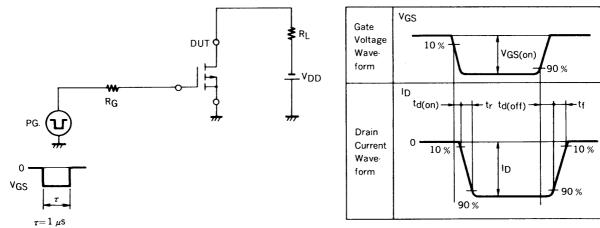


NEC

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SWITCHING TIME MEASUREMENT CIRCUIT AND CONDITIONS



Duty Cycle≦1 %

RECOMMENDED SOLDERING CONDITIONS

Mounting of this product by soldering should be done under the following conditions. Please consult our representatives about soldering methods and conditions other than these.

SURFACE MOUNT TYPE

For details of the recommended soldering conditions, see the information document. "Device Mounting Manual for Surface Mounting (IEI-1207)."

Soldering Method	Soldering Conditions	Symbol for Recommended Conditions	
Infrared Reflow	Package peak temp.: 230 °C Soldering time: within 30 sec (above 210 °C) Soldering times: 1, Days limitation: none*	IR30-00	
Vapor Phase Soldering	Package peak temp.: 215 °C Soldering time: within 40 sec (above 200 °C) Soldering times: 1, Days limitation: none*	VP15-00	
Wave Soldering	Soldering bath temp.: below 260 °C Soldering time: within 10 sec Soldering times: 1, Days limitation: none*	WS60-00	

*: Stored days under storage conditions at 25 °C and below 65 % R.H. after the dry-pack has been opened. Note 1 Combination of soldering methods should be avoided.

REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134

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Application examples recommended by NEC Corporation

Standard: Computer, Office equipment, Communication equipment, Test and Measurement equipment, Machine tools, Industrial robots, Audio and Visual equipment, Other consumer products, etc.

Special: Automotive and Transportation equipment, Traffic control systems, Antidisaster systems, Anticrime systems, etc.

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